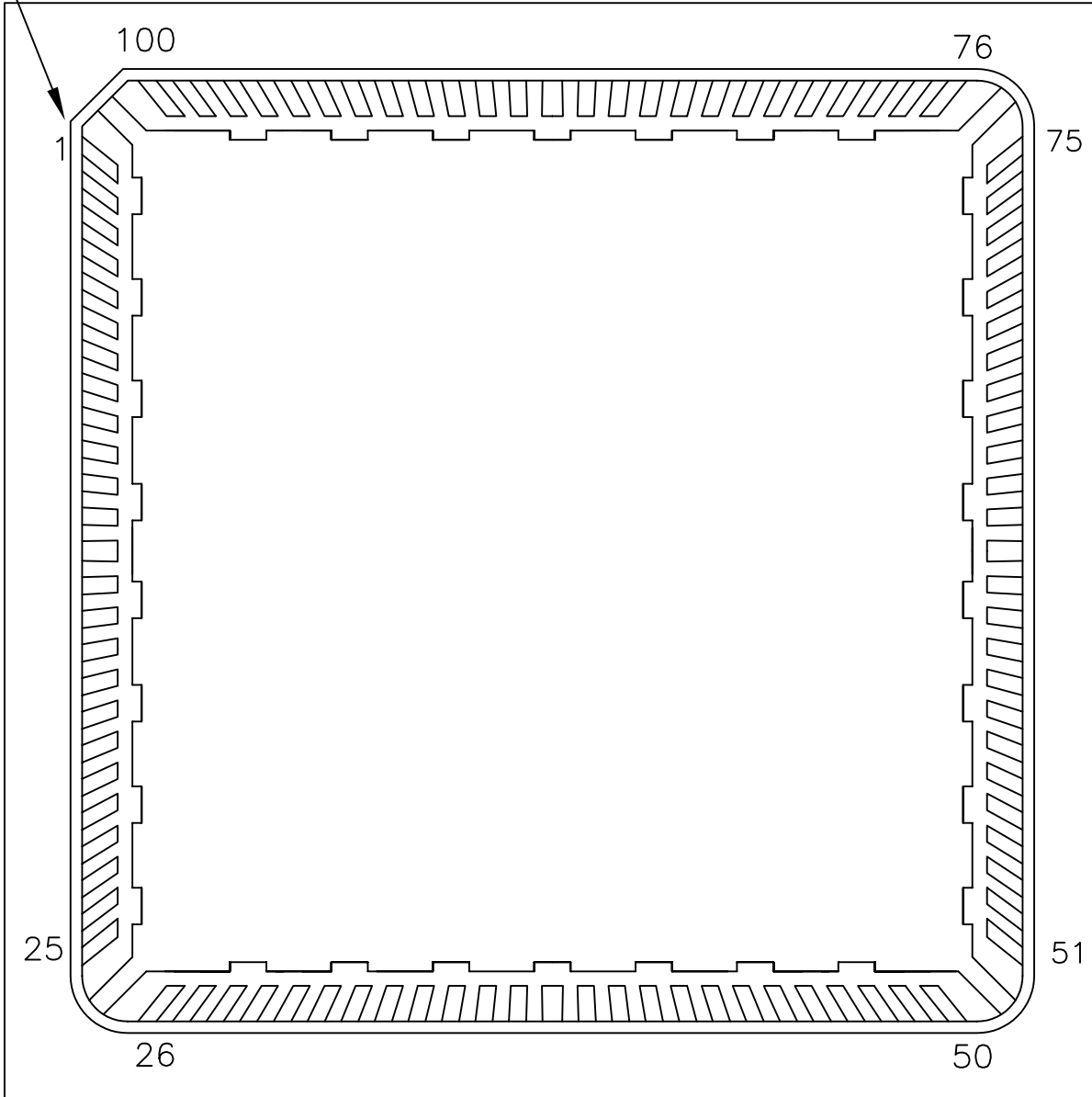


SEMPAC REVISIONS			
ECN NO.	DATE	DESCRIPTION	APPROVED
10857	01/16/06	PRODUCTION RELEASE	D.MORRIS
DRAWN BY	C. CRUZ	DATE	01/16/07
		APP BP.	FLASKERUD
		DATE	01/16/07

PIN #1 IDENTIFIER



DEVICE TYPE:		<b>SEMPAC, INC.</b> <b>Open-Pak™ Technologies</b> <a href="http://www.sempac.com">www.sempac.com</a> 568 E. WEDDELL DRIVE, SUITE 5 SUNNYVALE, CALIFORNIA 94089 PHONE: (408) 400-9002 FAX: (408) 400-9006	
CUSTOMER:			
WIRE TYPE/ SIZE:			
THIRD ANGLE PROJECTION	PACKAGE SIZE: 12.000mm X 12.000mm	100 LEAD 12mm X 12mm MLP Open-Pak™ BONDING DIAGRAM	
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETER DO NOT SCALE DRAWING	DIE PAD SIZE: 9.200mm X 9.200mm		
SEMPAC PART NO. MLP12X12-100-OP-01-B		THIS DOCUMENT CONTAINS INFORMATION PROPRIETARY TO SEMPAC, INC., AND REPRODUCTION OR ISSUE IN ANY FORM IS NOT PERMITTED WITHOUT WRITTEN AUTHORITY FROM SEMPAC, INC.	
SIZE A	PART NO. MLP12X12-100-OP-01	REV 2	
SCALE 32X	CAD FILE MLP12X12-100-OP-01-B-R2.DWG	SHEET 1 OF 1	